

DATASHEET

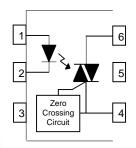
6 PIN DIP ZERO-CROSS TRIAC DRIVER PHOTOCOUPLER EL303X, EL304X, EL306X, EL308X Series



Features:

- Peak breakdown voltage
 - 250V: EL303X
 - 400V: EL304X
 - 600V: EL306X
 - 800V: EL308X
- High isolation voltage between input and output (Viso=5000 V rms)
- Zero voltage crossing
- Pb free and RoHS compliant.
- UL approved (No. E214129)
- VDE approved (No.132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CSA approved

Schematic



Pin Configuration

- 1. Anode
- 2. Cathode
- 3. No Connection
- 4. Terminal
- 5. Substrate (do not connect)
- 6. Terminal

Description

The EL303X, EL304X, EL306X and EL308X series of devices each consist of a GaAs infrared emitting diode optically coupled to a monolithic silicon zero voltage crossing photo triac.

They are designed for use with a discrete power triac in the interface of logic systems to equipment powered from 110 to 380 VAC lines, such as solid-state relays, industrial controls, motors, solenoids and consumer appliances.

Applications

- Solenoid/valve controls
- Light controls
- Static power switch
- AC motor drivers
- E.M. contactors
- Temperature controls
- AC Motor starters

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LifecyclePhase: Approved



Absolute Maximum Ratings (Ta=25)

	Parameter		Symbol	Rating	Unit
Input	Forward current		I _F	60	mA
	Reverse voltage		V _R	6	V
	Power dissipation		-	100	mW
	Derating factor (above	$T_a = 85^{\circ}C$	P _D -	3.8	mW /°C
Output		EL303X		250	
	Off-state Output	EL304X		400	_
	Terminal Voltage	EL306X	– V _{DRM} –	600	- V
		EL308X		800	_
	Peak Repetitive Surge (pw=1ms,120pps)	Current	I _{TSM}	1	A
	On-State RMS Current		I _{T(RMS)}	100	mA
	Power dissipation		D	300	mW
	Derating factor (above	$T_a = 85^{\circ}C$	P _C -	7.6	mW/
Total pow	ver dissipation		P _{TOT}	330	mW
Isolation voltage *1			V _{ISO}	5000	Vrms
Operating temperature			T _{OPR}	-55 to 100	
Storage temperature			T _{STG}	-55 to 125	
Soldering	g Temperature* ²		T _{SOL}	260	

Notes:

^{*1} AC for 1 minute, R.H.= $40 \sim 60\%$ R.H. In this test, pins 1, 2&3 are shorted together, and pins 4, 5 & 6 are shorted together.

^{*2} For 10 seconds



Electro-Optical Characteristics (Ta=25 unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Forward Voltage	V_{F}	-	-	1.5	V	I _F = 30mA
Reverse Leakage current	I _R	-	-	10	μΑ	V _R = 6V

Output

Parameter		Symbo I	Min.	Тур.*	Max.	Unit	Condition
Peak Blocking	EL303X EL304X				100	A	V _{DRM} = Rated V _{DRM}
Current	EL306X EL308X	- I _{DRM1}		-	500	nA	I _F = 0mA
Peak On-state \	Peak On-state Voltage V-		-	-	3	V	I _{TM} =100mA peak, I _F =Rated I _{FT}
Critical Rate of Rise off-state	EL303X EL304X EL306X	dv/dt	1000	-	-	V/µS	V _{PEAK} =Rated V _{DRM} , I _F =0 (Fig. 10)
Voltage	EL308X		600	-			(Fig. 10)
Inhibit Voltage (MT1-MT2 voltage above which device will not trigger)		V_{INH}		31	20	V	I _F = Rated I _{FT}
Leakage in Inhibited State		I _{DRM2}			500	μΑ	I_F = Rated I_{FT} , V_{DRM} =Rated V_{DRM} , off state

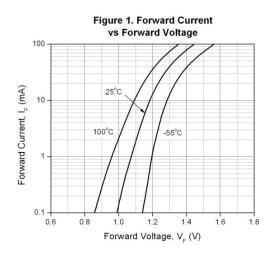
Transfer Characteristics

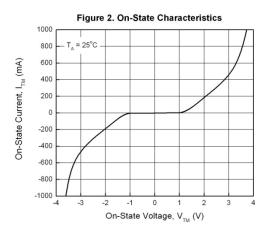
Parameter		Symbol	Min.	Тур.*	Max.	Unit	Condition
	EL3031 EL3041 EL3061 EL3081	– - I _{FT} -	-	-	15	- mA	Main terminal Voltage=3V
LED Trigger Current	EL3032 EL3042 EL3062 EL3082		-	-	10		
	EL3033 EL3043 EL3063 EL3083		-	-	5		
Holding Current		l _Η	-	280	-	μΑ	

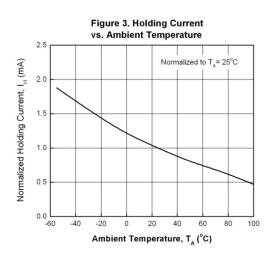
^{*} Typical values at T_a = 25°C

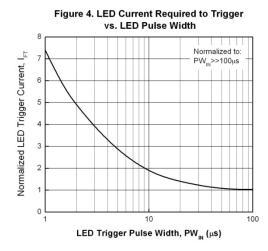


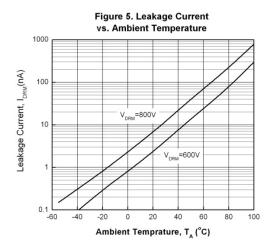
Typical Electro-Optical Characteristics Curves











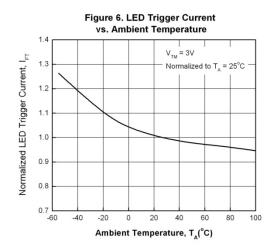


Figure 7. Off-State Output Terminal Voltage
vs. Ambient Temperature

1.4

Normalized to T_A = 25°C

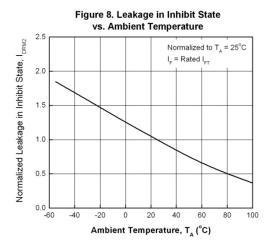
1.3

1.3

1.0

Normalized to T_A = 25°C

Ambient Temperature, T_A (°C)



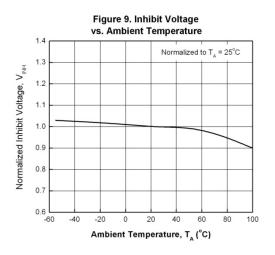
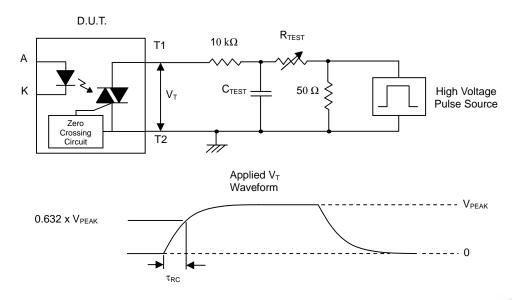


Figure 10. Static dv/dt Test Circuit & Waveform



Measurement Method

The high voltage pulse is set to the required V_{PEAK} value and applied to the D.U.T. output side through the RC circuit above. LED current is not applied. The waveform V_T is monitored using a x100 scope probe. By varying R_{TEST} , the dv/dt (slope) is increased, until the D.U.T. is observed to trigger (waveform collapses). The dv/dt is then decreased until the D.U.T. stops triggering. At this point, τ_{RC} is recorded and the dv/dt calculated.

$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$$

For example, $V_{PEAK} = 600V$ for EL306X series. The dv/dt value is calculated as follows:

$$dv/dt = \frac{0.63 \times 600}{\tau_{RC}} = \frac{378}{\tau_{RC}}$$



Order Information

Part Number

EL303XY(Z)-V or EL304XY(Z)-V or EL306XY(Z)-V or EL308XY(Z)-V

Note

X = Part No. (1, 2 or 3)

Y = Lead form option (S, S1, M or none)

Z = Tape and reel option (TA, TB or none).

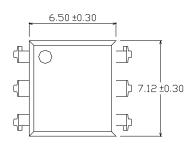
V = VDE safety approved option

Option	Description	Packing quantity
None	Standard DIP-6	65 units per tube
М	Wide lead bend (0.4 inch spacing)	65 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel

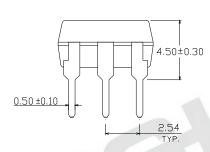


Package Dimension (Dimensions in mm)

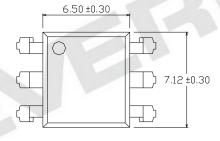
Standard DIP Type

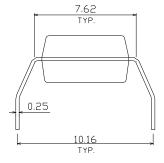


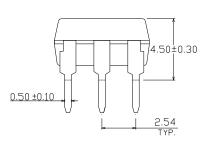




Option M Type

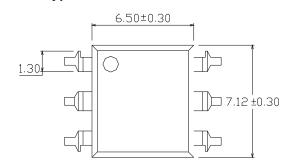


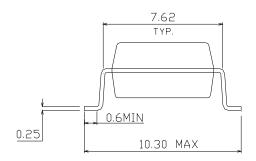


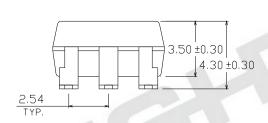




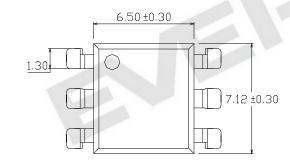
Option S Type

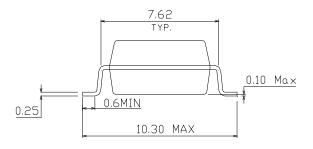


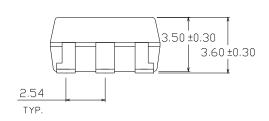




Option S1 Type

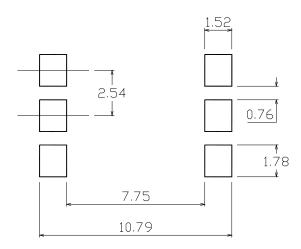




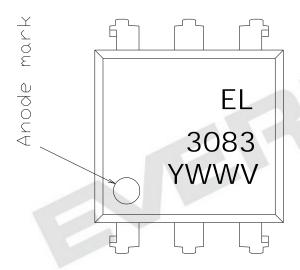




Recommended pad layout for surface mount leadform



Device Marking



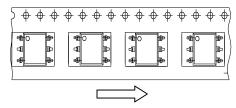
Notes

EL denotes Everlight
3083 denotes Device Number
Y denotes 1 digit Year code
WW denotes 2 digit Week code
V denotes VDE option



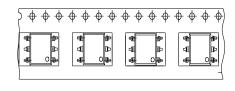
Tape & Reel Packing Specifications

Option TA



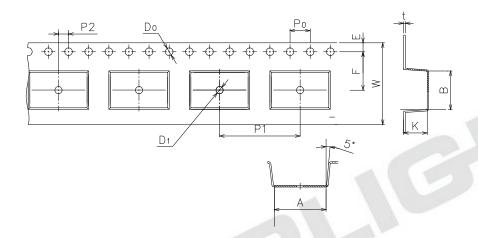
Direction of feed from reel

Option TB



Direction of feed from reel

Tape dimensions



Dimension No.	Α	В	Do	D1	E	F
Dimension (mm)	10.4±0.1	7.5±0.1	1.5±0.1	1.5+0.1/-0	1.75±0.1	7.5±0.1

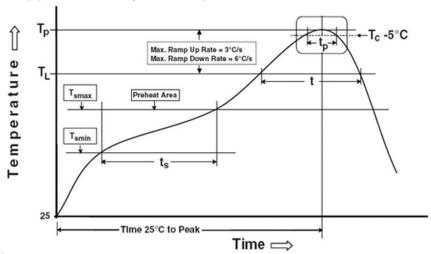
Dimension No.	Ро	P1	P2	t	w	К
Dimension (mm)	4.0±0.15	12±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1



Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note: Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min (T_{smin}) 150 °C

Temperature max (T_{smax}) 200 °C

Time $(T_{smin} \text{ to } T_{smax})$ (t_s) 60-120 seconds

Average ramp-up rate $(T_{smax} to T_p)$ 3 °C/second max

Other

Liquidus Temperature (T_L)

Time above Liquidus Temperature (t L) 60-1

Peak Temperature (T_P)

Time within 5 °C of Actual Peak Temperature: T_P - 5°C

Ramp- Down Rate from Peak Temperature

Time 25°C to peak temperature

Reflow times

217 °C

60-100 sec

260°C

30 s

6°C /second max.

8 minutes max.

3 times

12



DISCLAIMER

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